



40V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C	
40V	$7.3 \text{m}\Omega$ @ V _{GS} = 10V	73.0A	
40 V	$12m\Omega$ @ $V_{GS} = 4.5V$	58.0A	

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low Rds(ON) Minimizes Power Losses
- Wettable Flank for Improved Optical Inspection
- Fast Switching Speed
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH47M2LPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

PowerDI5060-8 (SWP) (Type UX)

- High Frequency Switching
- Synchronous Rectification
- DC-DC Converters

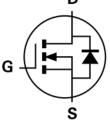
Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.097 grams (Approximate)

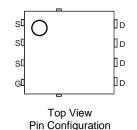




Bottom View



Internal Schematic



Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH47M2LPSWQ-13	PowerDI5060-8 (SWP) (Type UX)	2500/Tape & Reel

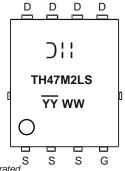
Notes:

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

Pin1

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



TH47M2LS = Product Type Marking Code

YYWW = Date Code Marking

YY = Year (ex: 20 = 2020)

WW = Week (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		VDSS	40	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current (Note 6) $ T_C = +25^{\circ}C $ $T_C = +100^{\circ}C $		ΙD	73.0 81.0	А
Maximum Continuous Body Diode Forward Current (Note 6)		Is	73.0	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	292	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		lsм	292	Α
Avalanche Current, L = 0.1mH		las	22.1	Α
Avalanche Energy, L = 0.1mH		Eas	24.4	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	3.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	39.4	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	Po	68	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	2.2	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

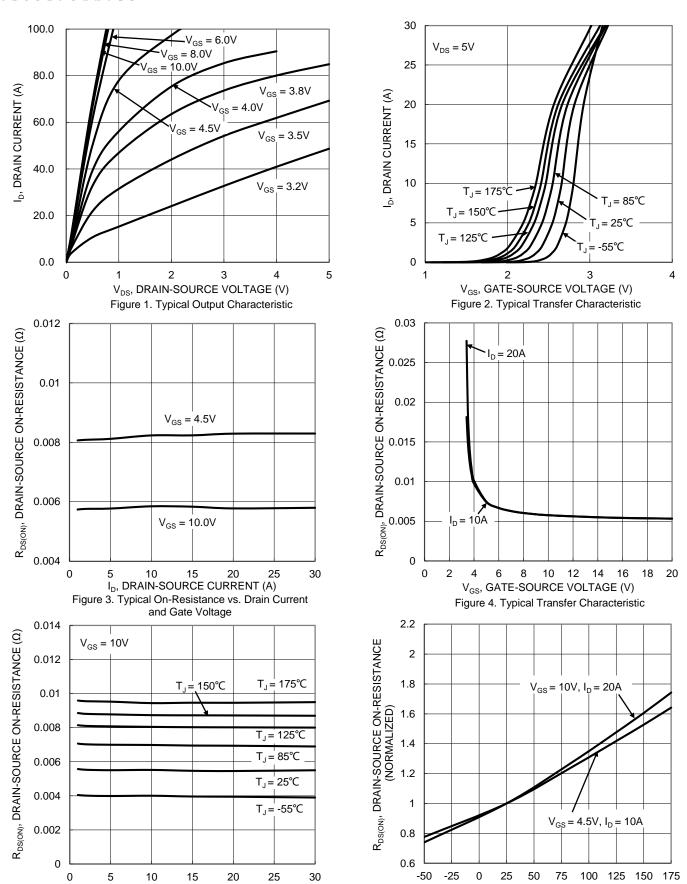
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 32V, V _{GS} = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	V _G S = ±20V, V _D S = 0V
ON CHARACTERISTICS (Note 7)		•	•	•		
Gate Threshold Voltage	Vgs(TH)	1.2	_	2.3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	D	_	5.7	7.3	mΩ	V _G S = 10V, I _D = 20A
Static Drain-Source On-Resistance	RDS(ON)	_	8.1	12	11122	V _G S = 4.5V, I _D = 10A
Diode Forward Voltage	V _{SD}	_	0.8	1.2	V	V _{GS} = 0V, I _S = 20A
DYNAMIC CHARACTERISTICS (Note 8)		•	•	•		
Input Capacitance	Ciss	_	891	_		V _{DS} = 20V, V _{GS} = 0V, f = 1MHz
Output Capacitance	Coss	_	490	_	pF	
Reverse Transfer Capacitance	Crss	_	14.8	_		
Gate Resistance	Rg	_	1.87	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 10V)	Qg	_	14.0	_		V _{DD} = 20V, I _D = 20A
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	6.7	_	nC	
Gate-Source Charge	Qgs	_	1.0	_	IIC	
Gate-Drain Charge	Qgd	_	2.5	_		
Turn-On Delay Time	t _D (ON)		3.9	_		V _{DD} = 20V, V _{GS} = 10V,
Turn-On Rise Time	t _R	_	5.4	_		
Turn-Off Delay Time	tD(OFF)	_	15.4	_	ns	$R_g = 3\Omega$, $I_D = 20A$
Turn-Off Fall Time	tF	_	8.5	_		
Body Diode Reverse Recovery Time	t _{RR}	_	56.6	_	ns	I- 204 di/dt 1004/up
Body Diode Reverse Recovery Charge	Q _{RR}		40.0	_	nC IF = 20A, di/dt = 100A/µs	

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. 6. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.





T_J, JUNCTION TEMPERATURE (°C)
Figure 6. On-Resistance Variation with Junction
Temperature

I_D, DRAIN CURRENT (A)

Figure 5. Typical On-Resistance vs. Drain Current and

Junction Temperature





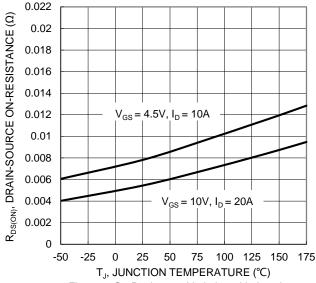


Figure 7. On-Resistance Variation with Junction Temperature

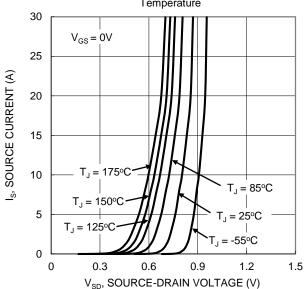


Figure 9. Diode Forward Voltage vs. Current

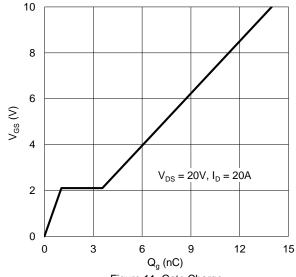


Figure 11. Gate Charge

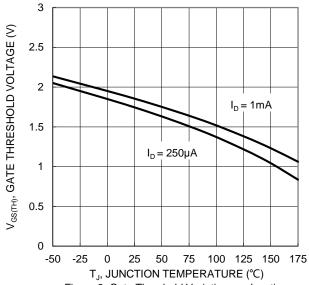


Figure 8. Gate Threshold Variation vs. Junction Temperature

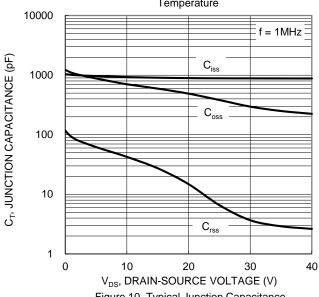
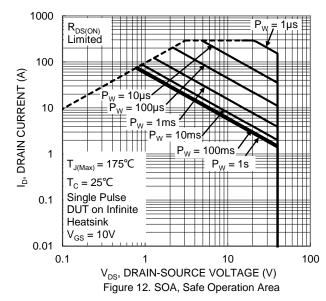


Figure 10. Typical Junction Capacitance





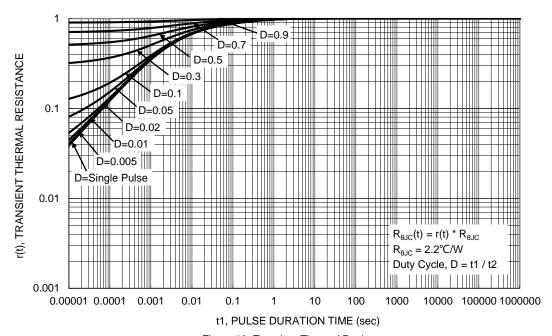


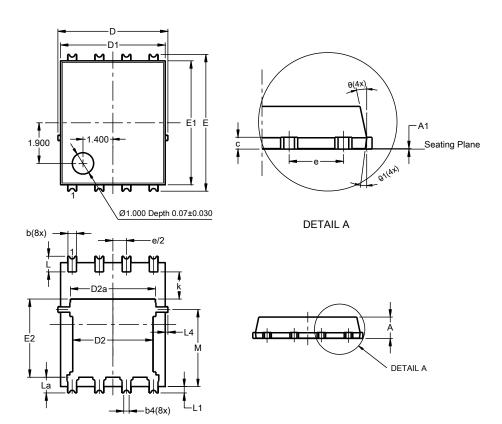
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)

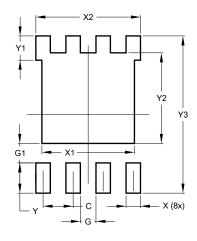


PowerDI5060-8 (SWP) (Type UX)				
Dim	Min	Тур		
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	:	
С	0.230	0.330	0.277	
D	5	.15 BS0	2	
D1	4.70 5.10 4.9			
D2	3.56	3.96	3.76	
D2a	3.78	3.98		
Е	6.40 BSC			
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1.27BSC			
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6° 8° 7°			
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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